

RELIABILITY MONITOR

PRODUCT	MONITOR DATE	DATE CODE	ASSEMBLY FACILITY	ASSEMBLY LOT NO	PROCESS TYPE	PACKAGE TYPE
DS12887 (w/BR1225)	Jan-96	9601 A2	DALLAS	DA078909AAA	N/A	24 MODULE

STRESS/JOB NO.

**READPOINT
(Sample Size/No. of Fails)**

Hi Temp Storage
85°C, No Bias
P-16816

48 Hr
200/0

Cum %
0.0%

Temp Cycle
0°C to +70°C
P-16862

300 ~ 1K ~
100/0 100/0

Cum %
0.0%

Biased Moisture
85°C/85% RH, 5.5 V.
P-16863

274 Hr 959 Hr
100/0 100/0

Cum %
0.0%

Phys. Dimen.
P-16815
6/0

Solderability
P-16814
24/0

Failure Mode